

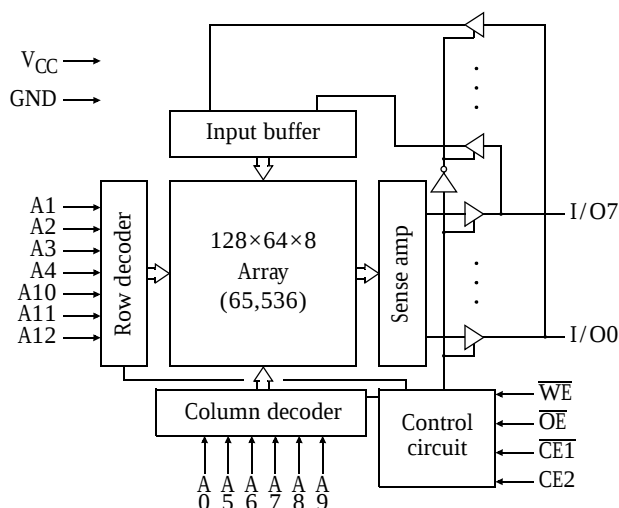


## 5V 8Kx8 CMOS SRAM

## Features

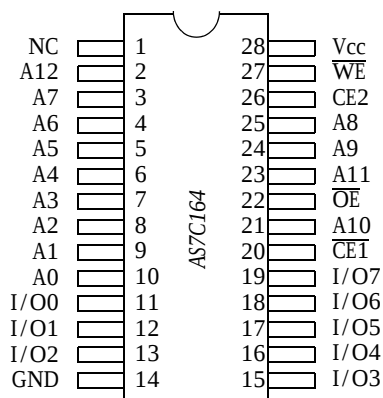
- AS7C164 (5V version)
- Commercial temperature
- Organization: 8,192 words  $\times$  8 bits
- Center power and ground pins
- High speed
  - 12/15/20 ns address access time
  - 6/7/8 ns output enable access time
- Low power consumption: ACTIVE
  - 550 mW (AS7C164) / max @ 12 ns
- Low power consumption: STANDBY
  - 11 mW (AS7C164) / max CMOS I/O
- 2.0V data retention
- Easy memory expansion with  $\overline{CE1}$ , CE2,  $\overline{OE}$  inputs
- TTL-compatible, three-state I/O
- 28-pin JEDEC standard package
  - 300 mil SOJ
- ESD protection  $\geq 2000$  volts
- Latch-up current  $\geq 200$  mA

## Logic block diagram



## Pin arrangement

28-pin PDIP, SOJ (300 mL)



## Selection guide

|                                   | -12 | -15 | -20 | Unit |
|-----------------------------------|-----|-----|-----|------|
| Maximum address access time       | 12  | 15  | 20  | ns   |
| Maximum output enable access time | 6   | 7   | 8   | ns   |
| Maximum operating current         | 110 | 100 | 90  | mA   |
| Maximum CMOS standby current      | 2.0 | 2.0 | 2.0 | mA   |



## Functional description

The AS7C164 is a high performance CMOS 65,536-bit Static Random Access Memory (SRAM) device organized as 8,192 words  $\times$  8 bits. It is designed for memory applications where fast data access, low power, and simple interfacing are desired.

Equal address access and cycle times ( $t_{AA}$ ,  $t_{RC}$ ,  $t_{WC}$ ) of 12/15/20 ns with output enable access times ( $t_{OE}$ ) of 6/7/8 ns are ideal for high performance applications. Active high and low chip enables ( $\overline{CE1}$ , CE2) permit easy memory expansion with multiple-bank memory systems.

When  $\overline{CE1}$  is High or CE2 is Low the device enters standby mode. The standard AS7C164 is guaranteed not to exceed 11.0 mW power consumption in standby mode, and typically requires only 250  $\mu$ W; it offers 2.0V data retention with maximum power of 120  $\mu$ W.

A write cycle is accomplished by asserting write enable ( $\overline{WE}$ ) and both chip enables ( $\overline{CE1}$ , CE2). Data on the input pins I/O0-I/O7 is written on the rising edge of  $\overline{WE}$  (write cycle 1) or the active-to-inactive edge of  $\overline{CE1}$  or CE2 (write cycle 2). To avoid bus contention, external devices should drive I/O pins only after outputs have been disabled with output enable ( $\overline{OE}$ ) or write enable ( $\overline{WE}$ ).

A read cycle is accomplished by asserting output enable ( $\overline{OE}$ ) and both chip enables ( $\overline{CE1}$ , CE2), with write enable ( $\overline{WE}$ ) High. The chip drives I/O pins with the data word referenced by the input address. When either chip enable or output enable is inactive, or write enable is active, output drivers stay in high-impedance mode.

All chip inputs and outputs are TTL-compatible, and operation is from a single 5V supply. The AS7C164 is packaged in 300 mil SOJ packages.

## Absolute maximum ratings

| Parameter                                 | Device  | Symbol     | Min   | Max             | Unit         |
|-------------------------------------------|---------|------------|-------|-----------------|--------------|
| Voltage on $V_{CC}$ relative to GND       | AS7C164 | $V_{t1}$   | -0.50 | +7.0            | V            |
| Voltage on any pin relative to GND        |         | $V_{t2}$   | -0.50 | $V_{CC} + 0.50$ | V            |
| Power dissipation                         |         | $P_D$      | —     | 1.0             | W            |
| Storage temperature (plastic)             |         | $T_{stg}$  | -65   | +150            | $^{\circ}$ C |
| Ambient temperature with $V_{CC}$ applied |         | $T_{bias}$ | -55   | +125            | $^{\circ}$ C |
| DC current into outputs (low)             |         | $I_{out}$  | —     | 20              | mA           |

NOTE: Stresses greater than those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions outside those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## Truth table

| $\overline{CE1}$ | CE2 | $\overline{WE}$ | $\overline{OE}$ | Data      | Mode                             |
|------------------|-----|-----------------|-----------------|-----------|----------------------------------|
| H                | X   | X               | X               | High Z    | Standby ( $I_{SB}$ , $I_{SB1}$ ) |
| X                | L   | X               | X               | High Z    | Standby ( $I_{SB}$ , $I_{SB1}$ ) |
| L                | H   | H               | H               | High Z    | Output disable ( $I_{CC}$ )      |
| L                | H   | H               | L               | $D_{out}$ | Read ( $I_{CC}$ )                |
| L                | H   | L               | X               | $D_{in}$  | Write ( $I_{CC}$ )               |

Key: X = Don't Care, L = Low, H = High



### Recommended operating conditions

| Parameter                     | Device  | Symbol   | Min   | Typical | Max        | Unit |
|-------------------------------|---------|----------|-------|---------|------------|------|
| Supply voltage                | AS7C164 | $V_{CC}$ | 4.5   | 5.0     | 5.5        | V    |
| Input voltage                 | AS7C164 | $V_{IH}$ | 2.2   | –       | $V_{CC}+1$ | V    |
|                               |         | $V_{IL}$ | -0.5* | –       | 0.8        | V    |
| Ambient operating temperature | AS7C164 | $T_A$    | 0     | –       | 70         | °C   |

\*  $V_{IL}$  min = -3.0V for pulse width less than  $t_{RC}/2$ .

### DC operating characteristics (over the operating range)<sup>1</sup>

| Parameter                      | Symbol     | Test Conditions                                                                                                                                                 | Device  | -12 |     | -15 |     | -20 |     | Unit |
|--------------------------------|------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|-----|-----|-----|-----|-----|-----|------|
|                                |            |                                                                                                                                                                 |         | Min | Max | Min | Max | Min | Max |      |
| Input leakage current          | $ I_{LI} $ | $V_{CC} = \text{Max},$<br>$V_{IN} = \text{GND to } V_{CC}$                                                                                                      |         | –   | 1   | –   | 1   | –   | 1   | μA   |
| Output leakage current         | $ I_{LO} $ | $V_{CC} = \text{Max},$<br>$\overline{CE1} = V_{IH} \text{ or } CE2 = V_{IL},$<br>$V_{OUT} = \text{GND to } V_{CC}$                                              |         | –   | 1   | –   | 1   | –   | 1   | μA   |
| Operating power supply current | $I_{CC}$   | $V_{CC} = \text{Max},$<br>$\overline{CE1} = V_{IL}, CE2 = V_{IH},$<br>$f = f_{Max}, I_{OUT} = 0 \text{ mA}$                                                     | AS7C164 | –   | 110 | –   | 100 | –   | 90  | mA   |
| Standby power supply current   | $I_{SB}$   | $V_{CC} = \text{Max},$<br>$\overline{CE1} = V_{IH} \text{ or } CE2 = V_{IL},$<br>$f = f_{Max}$                                                                  | AS7C164 | –   | 30  | –   | 25  | –   | 25  | mA   |
|                                | $I_{SB1}$  | $V_{CC} = \text{Max},$<br>$\overline{CE1} \geq V_{CC}-0.2V \text{ or}$<br>$CE2 \leq 0.2V,$<br>$V_{IN} \leq 0.2V \text{ or}$<br>$V_{IN} \geq V_{CC}-0.2V, f = 0$ | AS7C164 | –   | 2.0 | –   | 2.0 | –   | 2.0 | mA   |
| Output voltage                 | $V_{OL}$   | $I_{OL} = 8 \text{ mA}, V_{CC} = \text{Min}$                                                                                                                    |         | –   | 0.4 | –   | 0.4 | –   | 0.4 | V    |
|                                | $V_{OH}$   | $I_{OH} = -4 \text{ mA}, V_{CC} = \text{Min}$                                                                                                                   |         | 2.4 | –   | 2.4 | –   | 2.4 | –   | V    |

### Capacitance ( $f=1\text{MHz}$ , $T_a=25^\circ\text{C}$ , $V_{CC} = \text{NOMINAL}$ )<sup>2</sup>

| Parameter         | Symbol    | Signals                                                      | Test conditions         | Max | Unit |
|-------------------|-----------|--------------------------------------------------------------|-------------------------|-----|------|
| Input capacitance | $C_{IN}$  | A, $\overline{CE1}$ , CE2, $\overline{WE}$ , $\overline{OE}$ | $V_{in} = 0V$           | 5   | pF   |
| I/O capacitance   | $C_{I/O}$ | I/O                                                          | $V_{in} = V_{out} = 0V$ | 7   | pF   |



### Read cycle (over the operating range)<sup>3,9</sup>

| Parameter                                     | Symbol     | -12 |     | -15 |     | -20 |     | Unit | Notes    |
|-----------------------------------------------|------------|-----|-----|-----|-----|-----|-----|------|----------|
|                                               |            | Min | Max | Min | Max | Min | Max |      |          |
| Read cycle time                               | $t_{RC}$   | 12  | —   | 15  | —   | 20  | —   | ns   |          |
| Address access time                           | $t_{AA}$   | —   | 12  | —   | 15  | —   | 20  | ns   | 3        |
| Chip enable ( $\overline{CE1}$ ) access time  | $t_{ACE1}$ | —   | 12  | —   | 15  | —   | 20  | ns   | 3, 12    |
| Chip enable (CE2) access time                 | $t_{ACE2}$ | —   | 12  | —   | 15  | —   | 20  | ns   | 3, 12    |
| Output enable ( $\overline{OE}$ ) access time | $t_{OE}$   | —   | 6   | —   | 7   | —   | 8   | ns   |          |
| Output hold from address change               | $t_{OH}$   | 3   | —   | 3   | —   | 3   | —   | ns   | 5        |
| $\overline{CE1}$ Low to output in low Z       | $t_{CLZ1}$ | 3   | —   | 3   | —   | 3   | —   | ns   | 4, 5, 12 |
| CE2 High to output in low Z                   | $t_{CLZ2}$ | 3   | —   | 3   | —   | 3   | —   | ns   | 4, 5, 12 |
| $\overline{CE1}$ High to output in high Z     | $t_{CHZ1}$ | —   | 3   | —   | 4   | —   | 5   | ns   | 4, 5, 12 |
| CE2 Low to output in high Z                   | $t_{CHZ2}$ | —   | 3   | —   | 4   | —   | 5   | ns   | 4, 5, 12 |
| $\overline{OE}$ Low to output in low Z        | $t_{OLZ}$  | 0   | —   | 0   | —   | 0   | —   | ns   | 4, 5     |
| $\overline{OE}$ High to output in high Z      | $t_{OHZ}$  | —   | 3   | —   | 4   | —   | 5   | ns   | 4, 5     |
| Power up time                                 | $t_{PU}$   | 0   | —   | 0   | —   | 0   | —   | ns   | 4, 5, 12 |
| Power down time                               | $t_{PD}$   | —   | 12  | —   | 15  | —   | 20  | ns   | 4, 5, 12 |

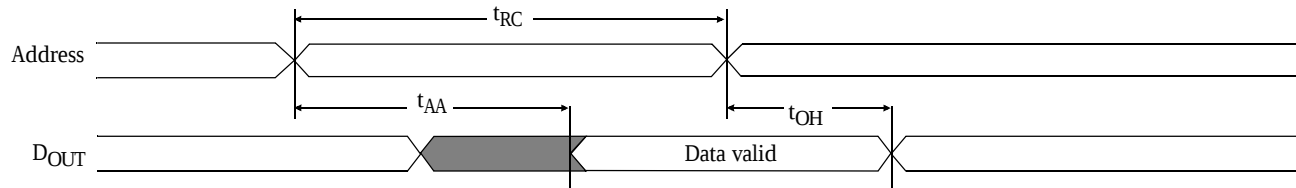
### Key to switching waveforms

— Rising input

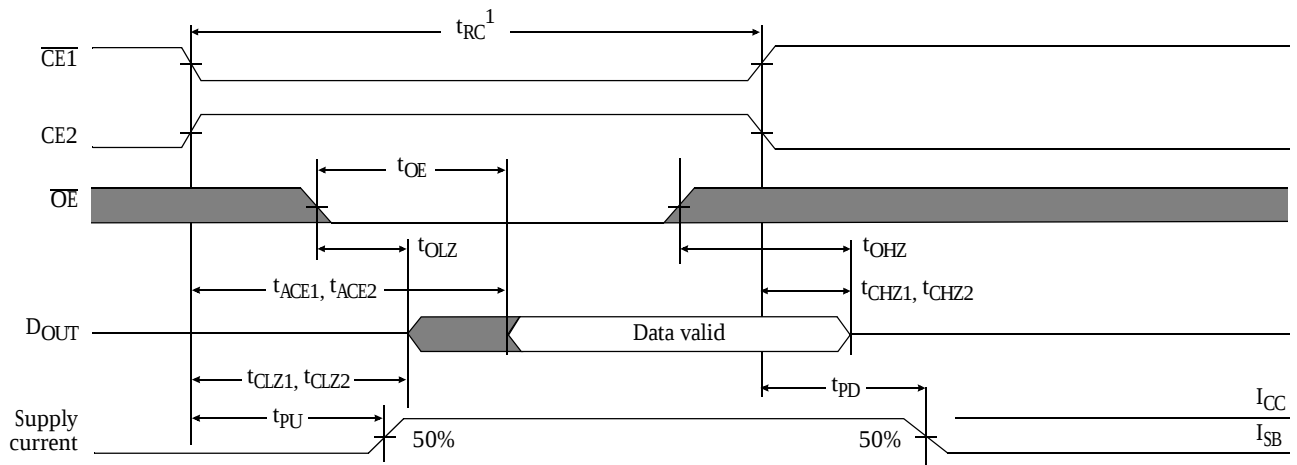
— Falling input

■ Undefined/don't care

### Read waveform 1 (address controlled)<sup>3, 6, 7, 9, 12</sup>



### Read waveform 2 ( $\overline{CE1}$ and CE2 controlled)<sup>3, 6, 8, 9, 12</sup>

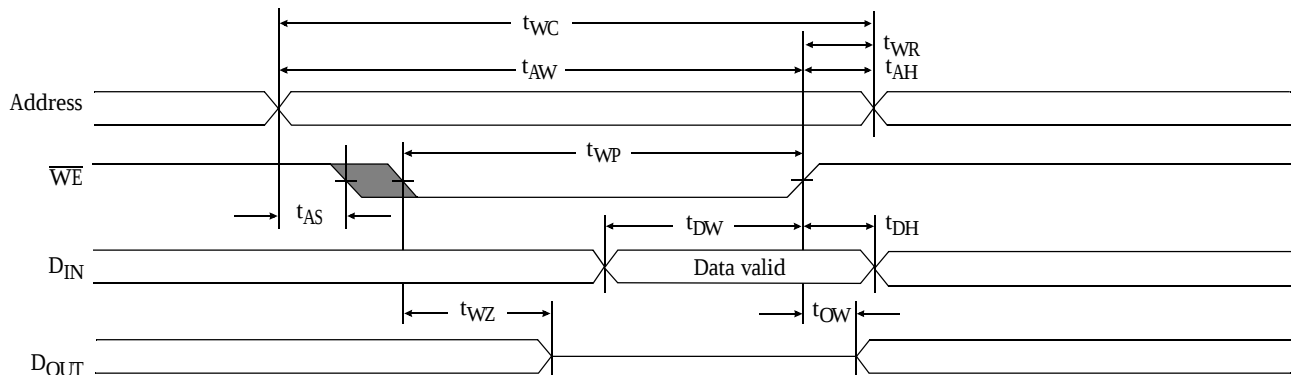




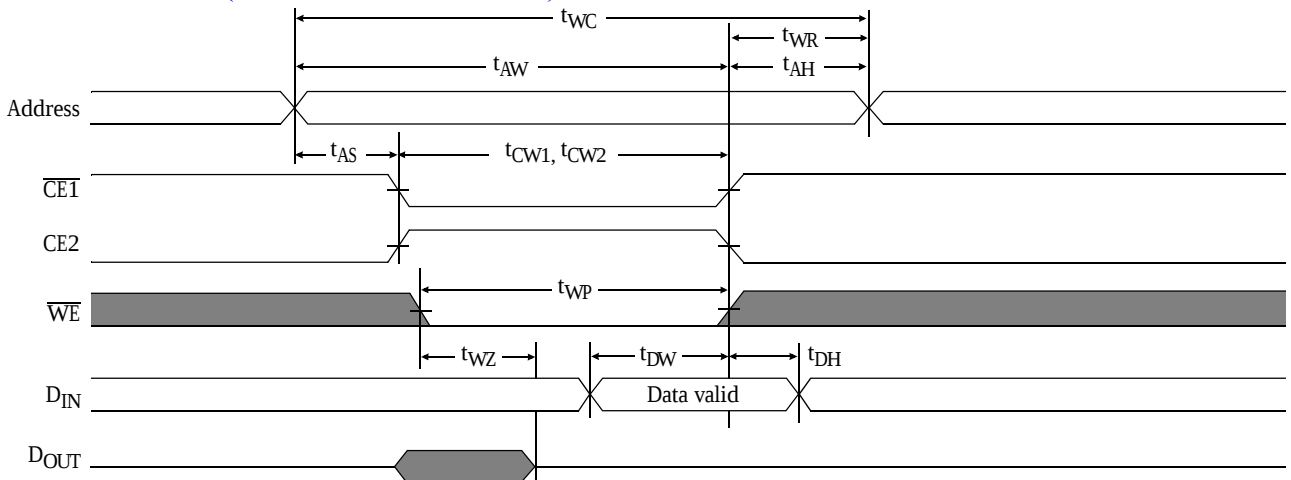
### Write cycle (over the operating range)<sup>11</sup>

| Parameter                                     | Symbol    | -12 |     | -15 |     | -20 |     | Unit | Notes |
|-----------------------------------------------|-----------|-----|-----|-----|-----|-----|-----|------|-------|
|                                               |           | Min | Max | Min | Max | Min | Max |      |       |
| Write cycle time                              | $t_{WC}$  | 12  | —   | 15  | —   | 20  | —   | ns   |       |
| Chip enable ( $\overline{CE1}$ ) to write end | $t_{CW1}$ | 9   | —   | 10  | —   | 12  | —   | ns   | 12    |
| Chip enable (CE2) to write end                | $t_{CW2}$ | 9   | —   | 10  | —   | 12  | —   | ns   | 12    |
| Address setup to write end                    | $t_{AW}$  | 9   | —   | 10  | —   | 12  | —   | ns   |       |
| Address setup time                            | $t_{AS}$  | 0   | —   | 0   | —   | 0   | —   | ns   | 12    |
| Write pulse width                             | $t_{WP}$  | 8   | —   | 9   | —   | 12  | —   | ns   |       |
| Write recovery time                           | $t_{WR}$  | 0   | —   | 0   | —   | 0   | —   | ns   |       |
| Address hold from write end                   | $t_{AH}$  | 0   | —   | 0   | —   | 0   | —   | ns   |       |
| Data valid to write end                       | $t_{DW}$  | 6   | —   | 7   | —   | 8   | —   | ns   |       |
| Data hold time                                | $t_{DH}$  | 0   | —   | 0   | —   | 0   | —   | ns   | 4, 5  |
| Write enable to output in high Z              | $t_{WZ}$  | —   | 5   | —   | 5   | —   | 5   | ns   | 4, 5  |
| Output active from write end                  | $t_{OW}$  | 3   | —   | 3   | —   | 3   | —   | ns   | 4, 5  |

### Write waveform 1 ( $\overline{WE}$ controlled)<sup>10, 11, 12</sup>



### Write waveform 2 ( $\overline{CE1}$ and CE2 controlled)<sup>10, 11, 12</sup>

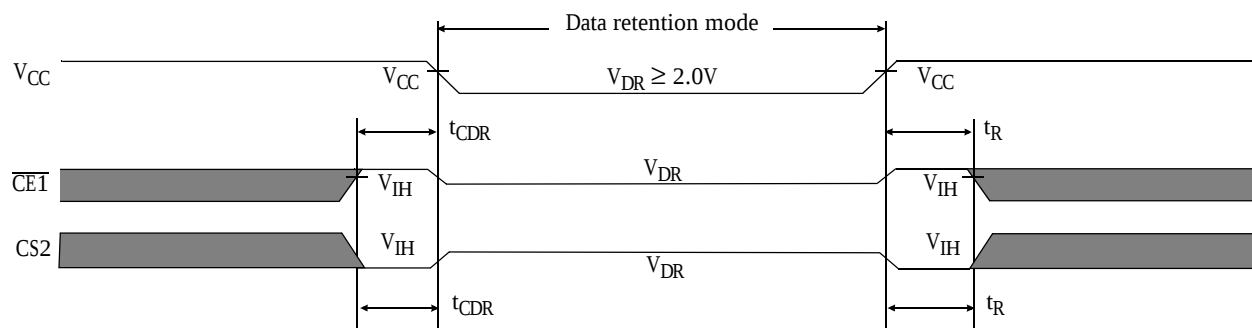




### Data retention characteristics (over the operating range)<sup>13</sup>

| Parameter                          | Symbol     | Test conditions                                                              | Min      | Max | Unit    |
|------------------------------------|------------|------------------------------------------------------------------------------|----------|-----|---------|
| $V_{CC}$ for data retention        | $V_{DR}$   | $V_{CC} = 2.0V$<br>$\overline{CE1} \geq V_{CC} - 0.2V$ or<br>$CE2 \leq 0.2V$ | 2.0      | —   | V       |
| Data retention current             | $I_{CCDR}$ |                                                                              | —        | 60  | $\mu A$ |
| Chip enable to data retention time | $t_{CDR}$  |                                                                              | 0        | —   | ns      |
| Operation recovery time            | $t_R$      |                                                                              | $t_{RC}$ | —   | ns      |

### Data retention waveform



### AC test conditions

- Output load: see Figure B or Figure C.
- Input pulse level: GND to 3.0V. See Figure A.
- Input rise and fall times: 2 ns. See Figure A.
- Input and output timing reference levels: 1.5V.

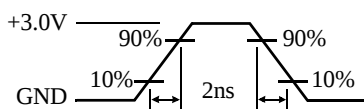


Figure A: Input pulse

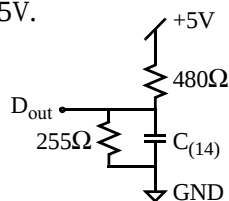


Figure B: 5V Output load

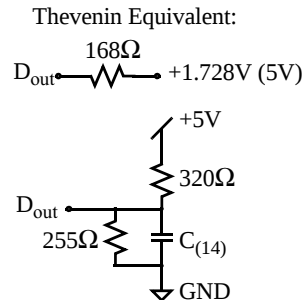


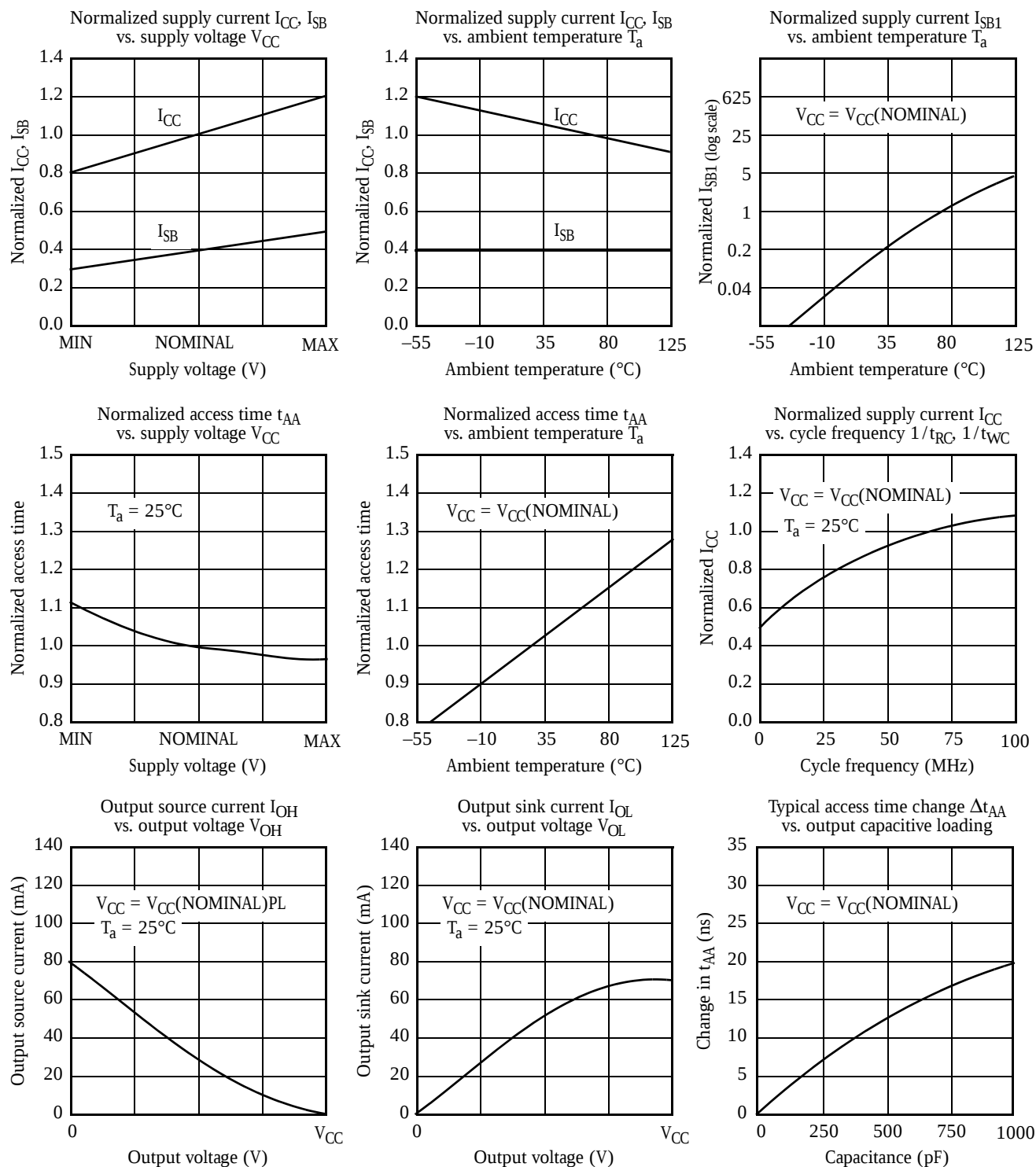
Figure C: 3.3V Output load

### Notes

- During  $V_{CC}$  power-up, a pull-up resistor to  $V_{CC}$  on  $\overline{CE1}$  is required to meet  $I_{SB}$  specification.
- This parameter is sampled, but not 100% tested.
- For test conditions, see *AC Test Conditions*, Figures A, B, and C.
- $t_{CLZ}$  and  $t_{CHZ}$  are specified with  $CL = 5pF$  as in Figures B or C. Transition is measured  $\pm 500mV$  from steady-state voltage.
- This parameter is guaranteed, but not 100% tested.
- $\overline{WE}$  is High for read cycle.
- $\overline{CE1}$  and  $\overline{OE}$  are Low and  $CE2$  is High for read cycle.
- Address valid prior to or coincident with  $\overline{CE1}$  transition Low and  $CE2$  transition High.
- All read cycle timings are referenced from the last valid address to the first transitioning address.
- $\overline{CE1}$  or  $\overline{WE}$  must be High or  $CE2$  Low during address transitions. Either  $\overline{CE}$  or  $\overline{WE}$  asserting high terminates a write cycle.
- All write cycle timings are referenced from the last valid address to the first transitioning address.
- $\overline{CE1}$  and  $CE2$  have identical timing.
- 2V data retention applies to the commercial operating range only.
- $C = 30pF$ , except on High Z and Low Z parameters, where  $C = 5pF$ .



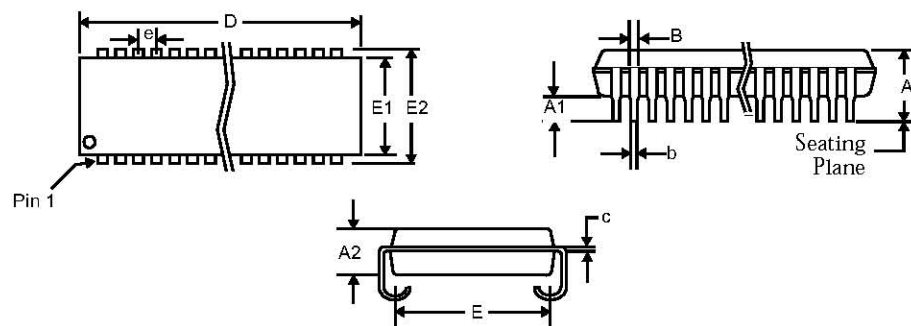
## Typical DC and AC characteristics





## Package dimensions

300 mil 28-pin SOJ



|    | 28-pin SOJ in mil |       |
|----|-------------------|-------|
|    | Min               | Max   |
| A  | -                 | 0.140 |
| A1 | 0.025             | -     |
| A2 | 0.095             | 0.105 |
| B  | 0.028 TYP         |       |
| b  | 0.018 TYP         |       |
| c  | 0.010 TYP         |       |
| D  | -                 | 0.730 |
| E  | 0.245             | 0.285 |
| E1 | 0.295             | 0.305 |
| E2 | 0.327             | 0.347 |
| e  | 0.050 BSC         |       |

## Ordering codes

| Package \ Access time | Volt/Temp     | 12 ns        | 15 ns        | 20 ns        |
|-----------------------|---------------|--------------|--------------|--------------|
| Plastic SOJ \ 300 mL  | 5V commercial | AS7C164-12JC | AS7C164-15JC | AS7C164-20JC |

## Part numbering system

|             |               |                        |             |                                |                                              |                    |
|-------------|---------------|------------------------|-------------|--------------------------------|----------------------------------------------|--------------------|
| AS7C        | 164           | X                      | -XX         | X                              | C                                            | X                  |
| SRAM prefix | Device number | Blank = Standard power | Access time | Package code:<br>J=SOJ 300 mil | Commercial temperature range,<br>0°C to 70°C | N = Lead Free Part |